Vishay Siliconix

RoHS

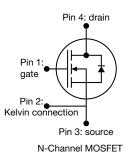
HALOGEN FREE

GREEN

(5-2008)

E Series Power MOSFET With Fast Body Diode





PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.087				
Q _g max. (nC)	135				
Q _{gs} (nC)	17				
Q _{gd} (nC)	45				
Configuration	Single				

FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH27N60EF-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unle	ss otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	V	
Gate-source voltage			V_{GS}	± 30	7 v	
Continuous drain current (T _{.1} = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	29	A	
Continuous drain current (1) = 130 C)	VGS at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		18		
Pulsed drain current ^a			I _{DM}	73		
Linear derating factor				1.6	W/°C	
Single pulse avalanche energy ^b			E _{AS}	353	mJ	
Maximum power dissipation			P_{D}	202	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$			dV/dt	100	V/ns	
Reverse diode dV/dt c				11	V/IIS	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A
- c. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum junction-to-ambient	R _{thJA}	38	50	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	0.48	0.62	C/VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.55	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Octo come lections	I _{GSS}	,	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage		,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zana mata walta na aluaina awamant		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 13.5 A		0.087	0.100	Ω
Forward transconductance	9 _{fs}	V _{DS} =	30 V, I _D = 13.5 A	-	9.6	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	2609	-	
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	125	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz			-	1
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	86	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	449	-	
Total gate charge	Q_{g}			-	90	135	
Gate-source charge	Q_{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 13.5 \text{ A}, V_{DS} = 480 \text{ V}$		17	-	nC
Gate-drain charge	Q _{gd}				45	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	$V_{DD} = 480 \text{ V}, I_D = 13.5 \text{ A},$		-	63	95	1
Turn-off delay time	t _{d(off)}		$= 10 \text{ V}, R_g = 9.1 \Omega$	-	101	152	- ns
Fall time	t _f			-	59	89	
Gate input resistance	R_g		f = 1 MHz		0.6	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed diode forward current	I _{SM}			-	-	73	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 13.5 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 13.5 A, dl/dt = 100 A/ μ s, V _R = 25 V		-	144	288	ns
Reverse recovery charge	Q _{rr}			-	0.9	1.8	μC
Reverse recovery current	I _{RRM}			-	12	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

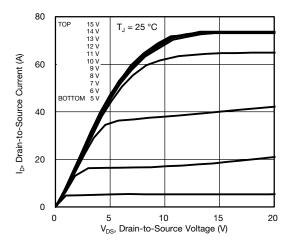


Fig. 1 - Typical Output Characteristics

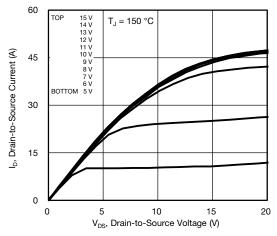


Fig. 2 - Typical Output Characteristics

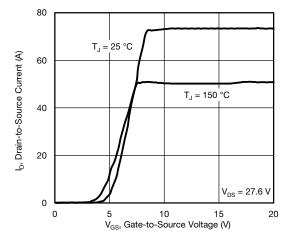


Fig. 3 - Typical Transfer Characteristics

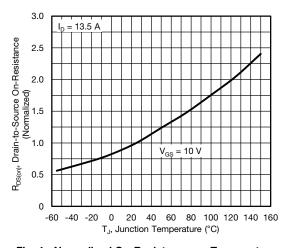


Fig. 4 - Normalized On-Resistance vs. Temperature

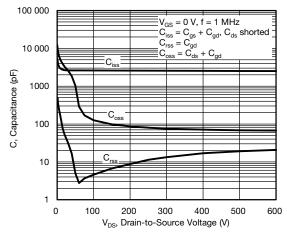


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

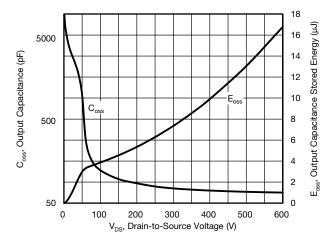


Fig. 6 - Coss and Eoss vs. VDS



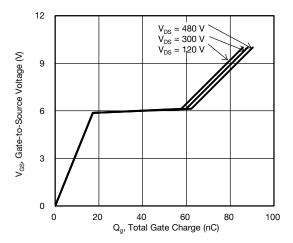


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

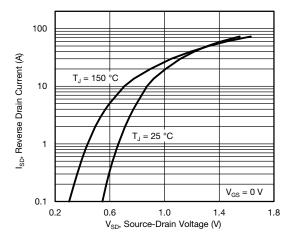


Fig. 8 - Typical Source-Drain Diode Forward Voltage

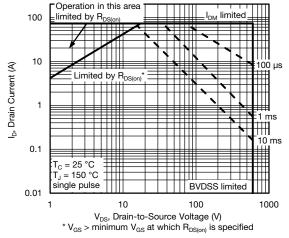


Fig. 9 - Maximum Safe Operating Area

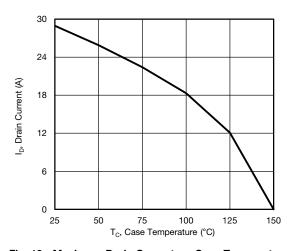


Fig. 10 - Maximum Drain Current vs. Case Temperature

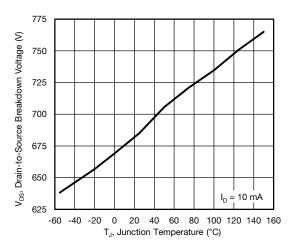


Fig. 11 - Temperature vs. Drain-to-Source Voltage



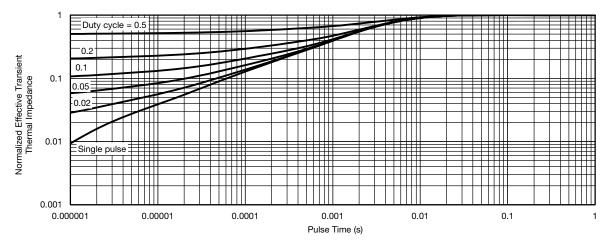


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

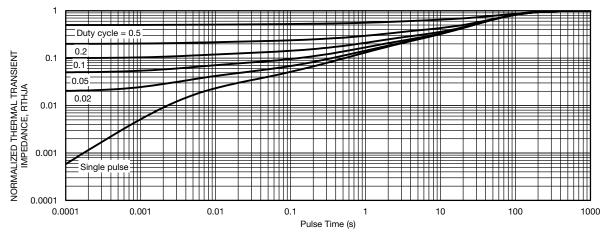


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

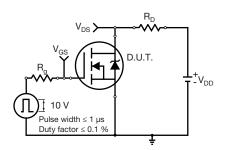


Fig. 14 - Switching Time Test Circuit

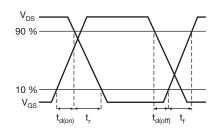


Fig. 15 - Switching Time Waveforms



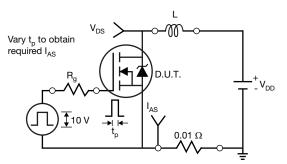


Fig. 16 - Unclamped Inductive Test Circuit

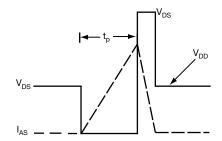


Fig. 17 - Unclamped Inductive Waveforms

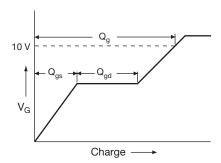


Fig. 18 - Basic Gate Charge Waveform

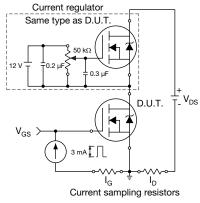
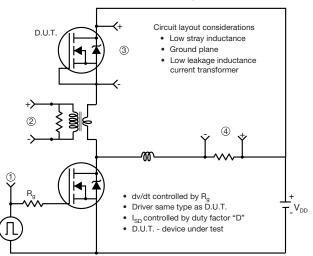


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



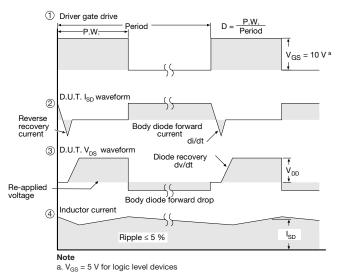


Fig. 20 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91985.



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PowerPAK® 8 x 8 Case Outline







DIM	MILLIMETERS			INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2		020 ref.			0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3	0.40 BSC		0.016 BSC					
е		2.00 BSC		0.079 BSC				
Е	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3	0.40 BSC			0.016 BSC				
K	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N ⁽³⁾	8			8 8				

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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